

STARPOWER

SEMICONDUCTOR™

IGBT

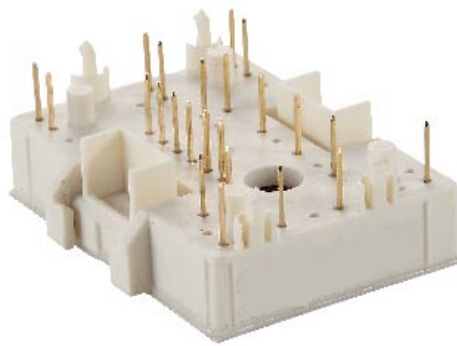
GD30PJK60L1S

Preliminary

Molding Type Module**600V/30A PIM in one-package**

General Description

STARPOWER IGBT Power Module provides ultra low conduction and switching loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- 10μs short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Square RBSOA
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

IGBT-inverter $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD30PJK60L1S	Units
V_{CES}	Collector-Emitter Voltage @ $T_J=25^{\circ}\text{C}$	600	V
V_{GES}	Gate-Emitter Voltage @ $T_J=25^{\circ}\text{C}$	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=80^{\circ}\text{C}$	45 30	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	60	A
P_{tot}	Total Power Dissipation @ $T_J=150^{\circ}\text{C}$	136	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_J=25^{\circ}\text{C}$	600			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V},$ $T_J=25^{\circ}\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V},$ $T_J=25^{\circ}\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=250\mu\text{A}, V_{CE}=V_{GE},$ $T_J=25^{\circ}\text{C}$	3.5	4.5	5.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=30\text{A}, V_{GE}=15\text{V},$ $T_J=25^{\circ}\text{C}$		1.95	2.40	V
		$I_C=30\text{A}, V_{GE}=15\text{V},$ $T_J=125^{\circ}\text{C}$		2.35		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Q_G	Gate charge	$V_{CC}=400\text{V}, I_C=30\text{A},$ $V_{GE}=15\text{V}$		102		nC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400\text{V}, I_C=30\text{A},$ $R_G=10\Omega, V_{GE}=15\text{V},$ $T_J=25^{\circ}\text{C}$		47		ns
t_r	Rise Time			30		ns
$t_{d(off)}$	Turn-Off Delay Time			190		ns
t_f	Fall Time			30		ns
E_{on}	Turn-On Switching Loss			0.35		mJ
E_{off}	Turn-Off Switching Loss			0.83		mJ

$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400V, I_C=30A,$ $R_G=10\Omega, V_{GE}=15V,$ $T_J=125^\circ C$		49		ns
t_r	Rise Time			30		ns
$t_{d(off)}$	Turn-Off Delay Time			205		ns
t_f	Fall Time			33		ns
E_{on}	Turn-On Switching Loss			0.64		mJ
E_{off}	Turn-Off Switching Loss			1.15		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz,$ $V_{GE}=0V$		1750		pF
C_{oes}	Output Capacitance			160		pF
C_{res}	Reverse Transfer Capacitance			60		pF
I_{SC}	SC Data	$T_P \leq 10\mu s, V_{GE}=15V,$ $T_J=125^\circ C, V_{CC}=360V,$ $V_{CEM} \leq 600V$		TBD		A

DIODE-inverter $T_C=25^\circ C$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD30PJK60L1S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_J=25^\circ C$	600	V
I_F	DC Forward Current @ $T_C=80^\circ C$	30	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	60	A

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V _F	Diode Forward Voltage	I _F =30A, V _{GE} =0V	T _j =25℃		1.30	1.70	V
			T _j =125℃		1.25		
t _r	Reverse Recovery Time	V _R =300V, I _F =30A, R _G =10Ω, V _{GE} =-15V	T _j =25℃		/		ns
			T _j =125℃		44		
I _{RM}	Peak Reverse Recovery Current		T _j =25℃		/		A
			T _j =125℃		125		
E _{rec}	Reverse Recovery Energy		T _j =25℃		/		mJ
			T _j =125℃		0.92		

DIODE-rectifier $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD30PJK60L1S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^{\circ}\text{C}$	1600	V
$I_{F(AV)}$	Average On-state Current @ $T_C=100^{\circ}\text{C}$	31	A
I_{RMSM}	Maximum RMS Current at Rectifier Output @ $T_C=80^{\circ}\text{C}$	60	A
I_{FSM}	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^{\circ}\text{C}$	320	A
I^2t	I^2t -value $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^{\circ}\text{C}$	510	A^2s

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=50\text{A}$	$T_j=150^{\circ}\text{C}$			1.38	V
I_R	Reverse Current	$T_j=150^{\circ}\text{C}, V_R=1600\text{V}$				2.0	mA

IGBT-brake-chopper $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD30PJK60L1S	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^{\circ}\text{C}$	600	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^{\circ}\text{C}$	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=80^{\circ}\text{C}$	45 30	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	60	A
P_{tot}	Total Power Dissipation @ $T_j=150^{\circ}\text{C}$	136	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^{\circ}\text{C}$	600			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V},$ $T_j=25^{\circ}\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V},$ $T_j=25^{\circ}\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=250\mu A, V_{CE}=V_{GE}, T_J=25^\circ C$	3.5	4.5	5.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=30A, V_{GE}=15V, T_J=25^\circ C$		1.95	2.40	V
		$I_C=30A, V_{GE}=15V, T_J=125^\circ C$		2.35		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Q_G	Gate charge	$V_{CC}=400V, I_C=30A, V_{GE}=15V$		102		nC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400V, I_C=30A, R_G=10\Omega, V_{GE}=15V, T_J=25^\circ C$		47		ns
t_r	Rise Time			30		ns
$t_{d(off)}$	Turn-Off Delay Time			190		ns
t_f	Fall Time			30		ns
E_{on}	Turn-On Switching Loss			0.35		mJ
E_{off}	Turn-Off Switching Loss			0.83		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=400V, I_C=30A, R_G=10\Omega, V_{GE}=15V, T_J=125^\circ C$		49		ns
t_r	Rise Time			30		ns
$t_{d(off)}$	Turn-Off Delay Time			205		ns
t_f	Fall Time			33		ns
E_{on}	Turn-On Switching Loss			0.64		mJ
E_{off}	Turn-Off Switching Loss			1.15		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz, V_{GE}=0V$		1750		pF
C_{oes}	Output Capacitance			160		pF
C_{res}	Reverse Transfer Capacitance			60		pF
I_{SC}	SC Data	$T_P \leq 10\mu s, V_{GE}=15V, T_J=125^\circ C, V_{CC}=360V, V_{CEM} \leq 600V$		TBD		A

DIODE-brake-chopper $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD30PJK60L1S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_J=25^{\circ}\text{C}$	600	V
I_F	DC Forward Current @ $T_C=80^{\circ}\text{C}$	10	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1\text{ms}$	20	A

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=10\text{A}, V_{GE}=0\text{V}$	$T_J=25^{\circ}\text{C}$	1.20	1.60	V
			$T_J=125^{\circ}\text{C}$	1.25		
t_r	Reverse Recovery Time	$V_R=300\text{V},$	$T_J=25^{\circ}\text{C}$	/		ns
			$T_J=125^{\circ}\text{C}$	90		
I_{RM}	Peak Reverse Recovery Current	$I_F=10\text{A},$ $R_G=47\Omega,$	$T_J=25^{\circ}\text{C}$	/		A
			$T_J=125^{\circ}\text{C}$	19		
E_{rec}	Reverse Recovery Energy	$V_{GE}=-15\text{V}$	$T_J=25^{\circ}\text{C}$	/		mJ
			$T_J=125^{\circ}\text{C}$	0.25		

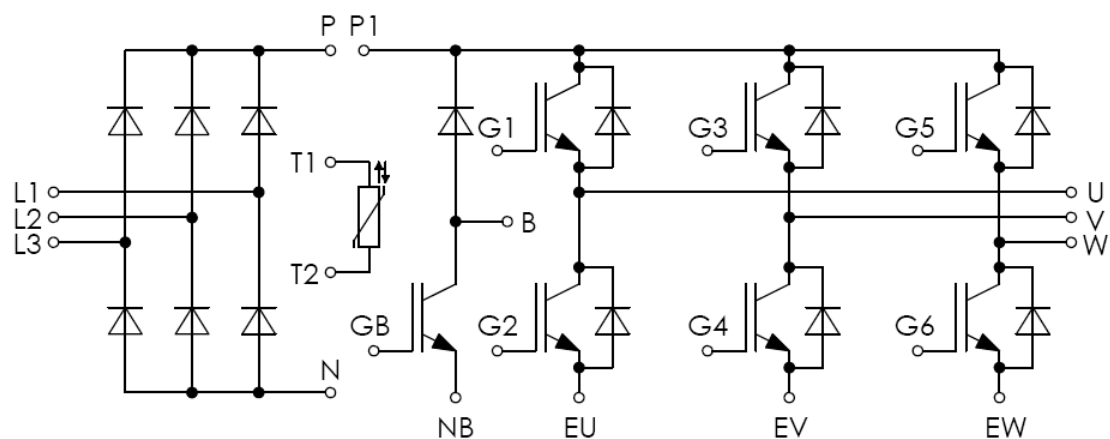
Electrical Characteristics of NTC $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
R_{25}	Rated Resistance			5.0		k Ω
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K

IGBT Module

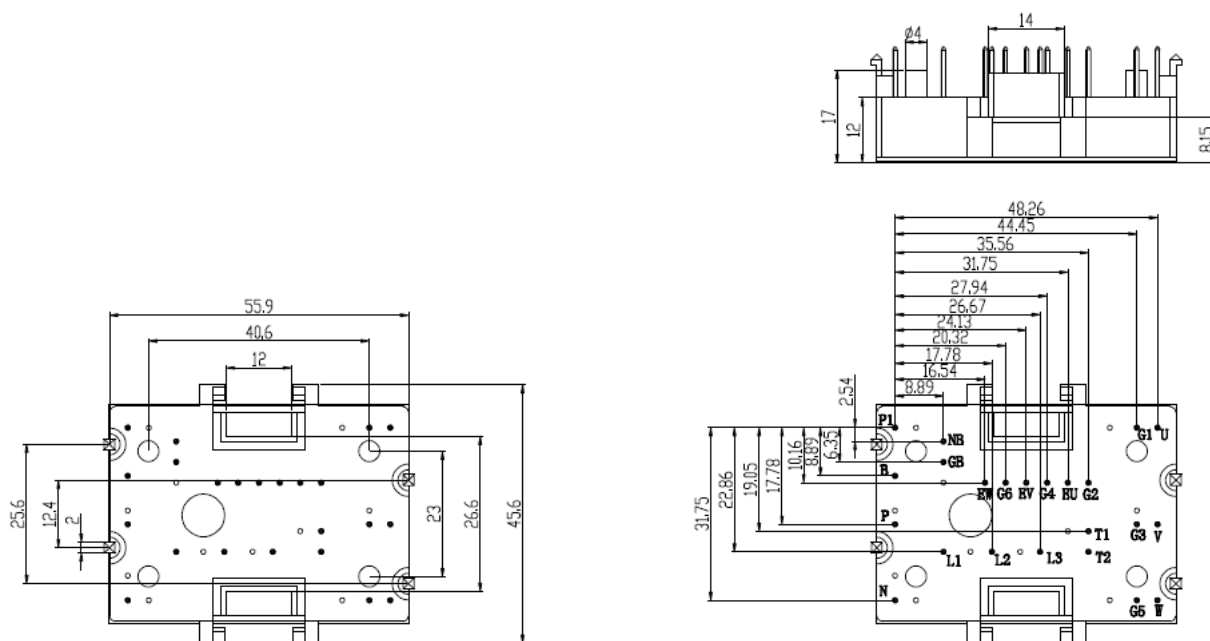
Symbol	Parameter	Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	2500			V
L_{CE}	Stray Inductance		40		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip @ $T_C=25^\circ\text{C}$		10		m Ω
$R_{\theta JC}$	Junction-to-Case (per IGBT-inverter)			0.92	K/W
	Junction-to-Case (per DIODE-inverter)			1.67	
	Junction-to-Case (per DIODE-rectifier)			1.16	
	Junction-to-Case (per IGBT-brake-chopper)			0.92	
	Junction-to-Case (per DIODE-brake-chopper)			2.84	
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)		0.03		K/W
T_j	Maximum Junction Temperature			150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-40		125	$^\circ\text{C}$
F	Mounting Force Per Clamp	40		80	N
G	Weight of Module		36		g

Equivalent Circuit Schematic



Package Dimension

Dimensions in Millimeters



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